

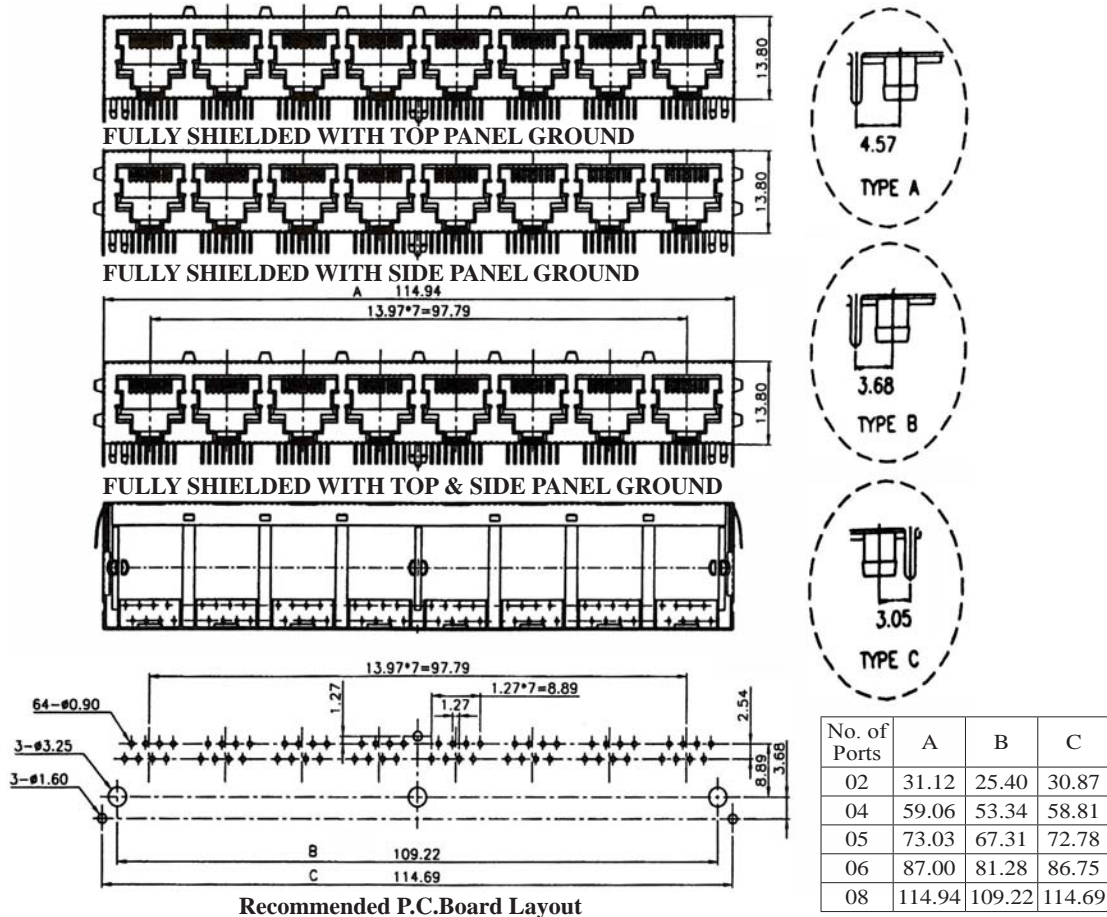
SIDE ENTRY MULTI-PORT MODULAR PCB JACK 8P+10P PROFILE=13.80MM (FULLY SHIELDED)

SPECIFICATIONS

Insulation Resistance: 500MΩ Min.
 Contact Resistance: 20mΩ Max.
 Rating Current: 1.5A Max.
 Rating Voltage: 120V AC.
 Dielectric Voltage: 1000 Vrms 60 Sec. Min.
 Temperature Range: -40°C / +85°C
 Durability: 500 Mating cycles Min.

MATERIALS

Housing: PBT Glass Filled (UL 94V-0)
 Soldering Temperature: 235°C
 Color: Black
 Spring Wire: Phosphor Bronze
 Gold plating Over Nickel
 Shield: Brass plating Nickel Alloy
 All materials must be RoHS compliant.



ORDERING INFORMATION:

P/N M J $\frac{x}{1} - \frac{x}{2} \frac{x}{3} B \frac{x}{4}$

1. CONTACT & PANEL GROUND TYPE:

WITH TOP PANEL GROUNDS:

"7G" TYPE A
 "7P" TYPE B
 "7Q" TYPE C

WITH SIDE PANEL GROUNDS:

"2E" TYPE A
 "2F" TYPE B
 "2G" TYPE C

WITH TOP & SIDE PANEL GROUNDS:

"2H" TYPE A
 "2K" TYPE B
 "2L" TYPE C

WITHOUT PANEL GROUNDS:

"7A" TYPE A
 "7B" TYPE B
 "3Y" TYPE C

2. NO. OF POSITIONS & CONTACTS:

"88" 8P8C
 "00" 10P10C

3. CONTACT FINISH:

"A" 6 MICROINCH GOLD
 "B" 15 MICROINCH GOLD
 "C" 30 MICROINCH GOLD
 "D" 50 MICROINCH GOLD

4. NO. OF PORTS:

02, 04, 05, 06, 08